

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	4	((("6611052") or ("6353267")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 18:51
L4	37	(wafer adj segment) with (chip die)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 21:33
L7	2	("6630685").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 20:16
L8	274	(segment) with (chips dice die) with (detach\$4 separat\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 20:20
L9	260	8 and @ad<="20030916"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 20:52
L10	2	("6630685").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 20:18
L11	10	(wafer adj segment) with (detach\$4 separat\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 20:39
L12	87	(wafer adj segment) with (chips dice die IC (integrated adj circuit))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/09 20:21
L13	12	("5936305" "6175161" "6181569" "6214642" "6228687" "6236109" "6239367" "6350668" "6365438" "6368896" "6389691" "6617687").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/09 20:30

L14	28	(wafer adj segment) with (detach\$4 separat\$4 saw\$4 dic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 21:54
L16	292	(group near2 (dice chips)) with (detach\$4 separat\$4 saw\$4 dic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 21:20
L17	247	16 and @ad<="20030916"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 20:44
L20	2	"20040043533"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 21:19
L21	0	("2004/0043533").URPN.	USPAT	OR	OFF	2005/11/09 20:54
L22	12	("5936305" "6175161" "6181569" "6214642" "6228687" "6236109" "6239367" "6350668" "6365438" "6368896" "6389691" "6617687").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/09 20:55
L23	25	("5072283" "5155302" "5206585" "5434357" "5440240" "5477160" "5593927" "5674785" "5678301" "5739585" "5770889" "5773322" "5783865" "5789278" "5879761" "5889326" "5892271" "5910641" "5915755" "6001724" "6002180" "6013948" "6020220" "6097087" "6107122").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/09 21:02
L24	2	("5789278").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 21:02

L25	26	("4899921" "4937653" "4992850" "5072289" "5206585" "5249450" "5262718" "5326428" "5408190" "5419807" "5428223" "5440240" "5458694" "5474620" "5478779" "5483174" "5483741" "5487999" "5519332" "5578526" "5578537" "5607818" "5634267" "5661042" "5668059" "5678301").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/09 21:03
L26	362	wafer with group with (chips dice)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 21:19
L27	315	26 and @ad<="20030916"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 21:19
L28	252	27 and (detach\$4 separat\$4 saw\$4 dic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 21:26
L29	16	((("20020050585") or ("20020070443") or ("6423570") or ("6518163") or ("20030036257") or ("6709898") or ("6734534") or ("6867499")). PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 21:27
L30	4	(unitar\$4 adj segment\$4) with (chip die IC (integrated adj circuit))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 21:34
L31	138	(wafer adj segments) with wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 22:06
L32	2	("6627917").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/09 22:06

L33	17	("4768073" "5047711" "5053700" "5389556" "5442282" "5489538" "5504369" "5532174" "5539325" "5593903" "5600257" "5648661" "5661042" "5766979" "5895967" "6118138" "6274395").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/09 22:32
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